

359B-VB Datasheet

N-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)		
30	0.030 at V _{GS} = 10 V	6.5	4.5 nC		
50	0.033 at V _{GS} = 4.5 V	6.0	4.5110		

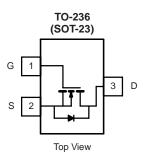
FEATURES

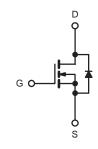
- Halogen-free According to IEC 61249-2-21
 Definition
- TrenchFET[®] Power MOSFET
- 100 % R_g Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

DC/DC Converter









Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	30	V	
Gate-Source Voltage		V _{GS}	± 20	v	
	T _C = 25 °C		6.5 ^a		
Continuous Drain Current ($T_1 = 150 \ ^{\circ}C$)	T _C = 70 °C		6.0		
Continuous Drain Current (1) = 150°C)	T _A = 25 °C	I _D	5.3		
	T _A = 70 °C		5.0	A	
Pulsed Drain Current		I _{DM}	25		
	T _C = 25 °C		1.4		
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	0.9 ^{b, c}		
	T _C = 25 °C		1.7		
Maximum Power Dissipation	T _C = 70 °C	P _D	1.1	w	
	T _A = 25 °C		1.1 ^{b, c}	VV	
	T _A = 70 °C	1	0.7 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	
Soldering Recommendations (Peak Temperature) ^{d, e}			260	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, d}	t ≤ 5 s	R _{thJA}	90	115	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	60 75 6/7		0/11	

Notes:

a. Package limited

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 5 s.

d. Maximum under steady state conditions is 130 °C/W.

Symbol	Test Conditions	Min.	Тур.	Max.	Unit
I			1	1	1
	V _{GS} = 0 V, I _D = 250 μA	30			V
$\Delta V_{DS}/T_{J}$	l _D = 250 μA		31		mV/°0
$\Delta V_{GS(th)}\!/T_J$. <u>D</u> = 200 µ. (- 5		111.07
V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	0.7	1.1	2.0	V
I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
1	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$			1	
DSS	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 \text{ °C}$			10	μA
I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	10			Α
Р	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 3.2 \text{ A}$		0.030		0
R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 2.8 \text{ A}$		0.033		Ω
9 _{fs}	V _{DS} = 15 V, I _D = 4.8 A		11		S
				I	1
Ciss			335		
	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz		45		pF
			17		
	V _{DS} = 15 V, V _{GS} = 10 V, I _D = 3.4 A	17 4.5	6.7	<u> </u>	
Qg			2.1	3.2	nC
Q _{as}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 3.4 \text{ A}$		0.85		
			0.65		
-	f = 1 MHz	0.8	4.4	8.8	Ω
			12	20	
	$V_{DD} = 15 \text{ V}. \text{ R}_{1} = 5.6 \Omega$		50	75	-
				20	
				10	ns
	$V_{DD} = 15 V R_1 = 56 \Omega$		-	20	-
-				-	
	2 0 <u>2</u> ., g				
•			-		
	T _C = 25 °C			1.4	
	-				A
	$I_{S} = 2.7 \text{ A}, V_{GS} = 0 \text{ V}$		0.8		V
	<u> </u>				ns
		<u> </u>	-		nC
t _a	I_F = 2.7 A, dI/dt = 100 A/µs, T _J = 25 °C	<u> </u>	6		
	Symbol V_{DS} $\Delta V_{DS}/T_J$ $\Delta V_{GS}(th)/T_J$ $\Delta V_{GS}(th)$ I_{GSS} $I_{D(on)}$ $R_{DS(on)}$ gfs C_{iss} C_{oss} C_{rss} Q_{gd} R_g $t_{d(on)}$ t_r $t_{d(off)}$ t_r $t_{d(off)}$ t_r $t_{d(off)}$ t_r I_{SM} V_{SD} t_{rr}	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{tabular}{ c c c c c } \hline Symbol & Test Conditions & Min. \\ \hline V_{DS} & V_{GS} = 0 \ V, \ I_D = 250 \ \mu A & 30 \\ \hline \Delta V_{DS}/T_J & I_D = 250 \ \mu A & 0.7 \\ \hline I_D = 250 \ \mu A & 0.7 \\ \hline V_{GS}(th) & V_{DS} = V_{GS} \ . \ I_D = 250 \ \mu A & 0.7 \\ \hline I_{GSS} & V_{DS} = 0 \ V, \ V_{GS} = \pm 20 \ V & V_{DS} = 30 \ V, \ V_{GS} = 0 \ V & T_J = 55 \ ^{\circ}C & 0.7 \\ \hline I_{D}(n) & V_{DS} \ge 5 \ V, \ V_{GS} = 0 \ V & T_J = 55 \ ^{\circ}C & 0.7 \\ \hline I_{D}(n) & V_{DS} \ge 5 \ V, \ V_{GS} = 10 \ V & 10 & 0.7 \\ \hline R_{DS}(n) & V_{DS} = 30 \ V, \ V_{GS} = 10 \ V & 10 & 0.7 \\ \hline R_{DS}(n) & V_{DS} = 30 \ V, \ V_{GS} = 0 \ V, \ T_J = 55 \ ^{\circ}C & 0.7 \\ \hline I_{D}(n) & V_{DS} \ge 5 \ V, \ V_{GS} = 10 \ V & 10 & 0.7 \\ \hline R_{DS}(n) & V_{DS} = 15 \ V, \ V_{GS} = 0 \ V, \ f = 1 \ MHz & 0.8 \\ \hline C_{iss} & V_{DS} = 15 \ V, \ V_{GS} = 0 \ V, \ f = 1 \ MHz & 0.8 \\ \hline C_{iss} & V_{DS} = 15 \ V, \ V_{GS} = 10 \ V, \ I_D = 3.4 \ A & 0.7 \\ \hline Q_{g} & V_{DS} = 15 \ V, \ V_{GS} = 10 \ V, \ I_D = 3.4 \ A & 0.7 \\ \hline Q_{g} & V_{DS} = 15 \ V, \ V_{GS} = 10 \ V, \ I_D = 3.4 \ A & 0.7 \\ \hline R_{g} & f = 1 \ MHz & 0.8 \\ \hline T_{d}(n) & I_D \cong 2.7 \ A, \ V_{GEN} = 4.5 \ V, \ R_{g} = 1 \ \Omega & 0.8 \\ \hline T_{d}(on) & I_D \cong 2.7 \ A, \ V_{GEN} = 4.5 \ V, \ R_{g} = 1 \ \Omega & 0.8 \\ \hline T_{d}(off) & I_D \cong 2.7 \ A, \ V_{GEN} = 10 \ V, \ R_{g} = 1 \ \Omega & 0.8 \\ \hline T_{d}(off) & I_D \cong 2.7 \ A, \ V_{GEN} = 10 \ V, \ R_{g} = 1 \ \Omega & 0.8 \\ \hline T_{d}(off) & I_D \cong 2.7 \ A, \ V_{GEN} = 10 \ V, \ R_{g} = 1 \ \Omega & 0.8 \\ \hline T_{d}(off) & I_D \cong 2.7 \ A, \ V_{GEN} = 10 \ V, \ R_{g} = 1 \ \Omega & 0.8 \\ \hline T_{d}(off) & I_D \cong 2.7 \ A, \ V_{GEN} = 10 \ V, \ R_{g} = 1 \ \Omega & 0.8 \\ \hline T_{d}(off) & I_D \cong 2.7 \ A, \ V_{GEN} = 0 \ V & 0.8 \\ \hline T_{d}(off) & I_D \cong 2.7 \ A, \ V_{GEN} = 0 \ V & 0.8 \\ \hline T_{d}(f) & I_D \cong 2.7 \ A, \ V_{GEN} = 0 \ V & 0.8 \\ \hline T_{d}(f) & I_D \cong 2.7 \ A, \ V_{GEN} = 0 \ V & 0.8 \\ \hline T_{d}(f) & I_D \cong 2.7 \ A, \ V_{GEN} = 0 \ V & 0.8 \\ \hline T_{d}(f) & I_D \cong 2.7 \ A, \ V_{GEN} = 0 \ V & 0.8 \\ \hline T_{d}(f) & I_D \cong 2.7 \ A, \ V_{GEN} = 0 \ V & 0.8 \\ \hline T_{d}(f) & I_D \cong 2.7 \ A, \ V_{GEN} = 0 \ V & 0.8 \\ \hline T_{d}(f) & I_D \cong 2.7$	$\begin{tabular}{ c c c c c } \hline Symbol & Test Conditions & Min. Typ. \\ \hline V_{DS} & V_{GS} = 0 \ V, \ I_D = 250 \ \mu A & 30 & 31 & 31 & 30 & 30 & 31 & 31 & 30 & 30$	$\begin{tabular}{ c c c c c c c } \hline \mathbf{Y}_{DS} & $V_{GS} = 0 \ V, \ I_D = 250 \ \mu A$ & 30 & 31 & 11 & 10 & 11 & 10 & 10 & 11 & 10 & $10$$

Notes:

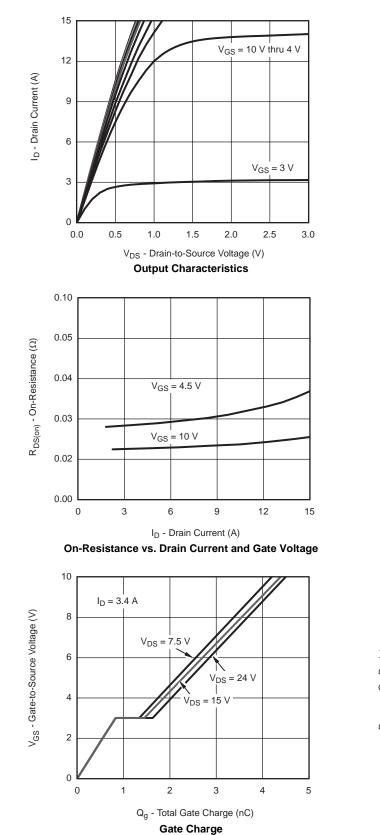
a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing.

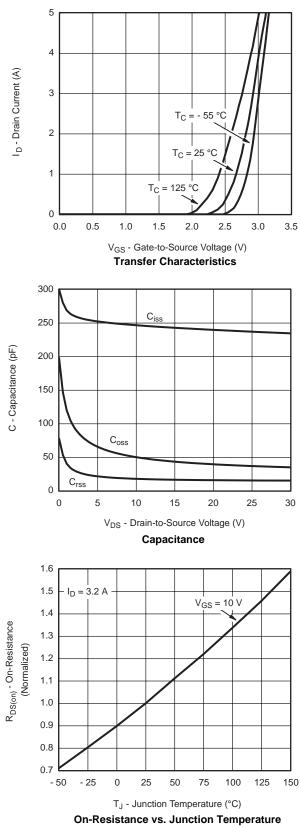
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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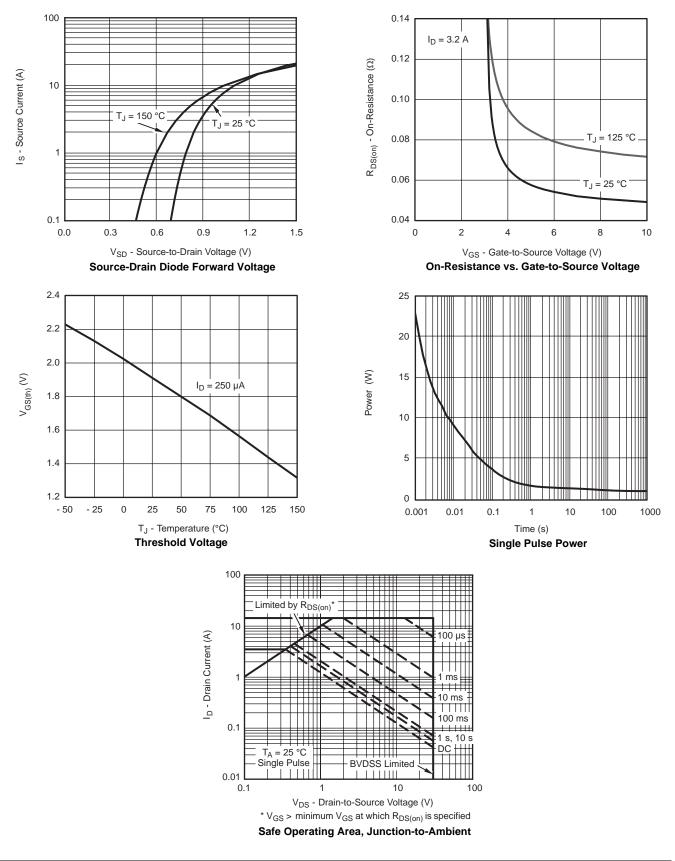




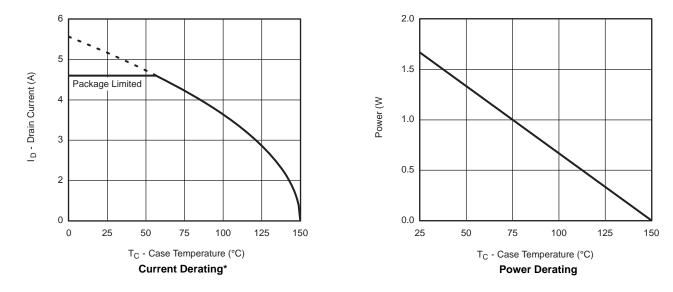
服务热线:400-655-8788





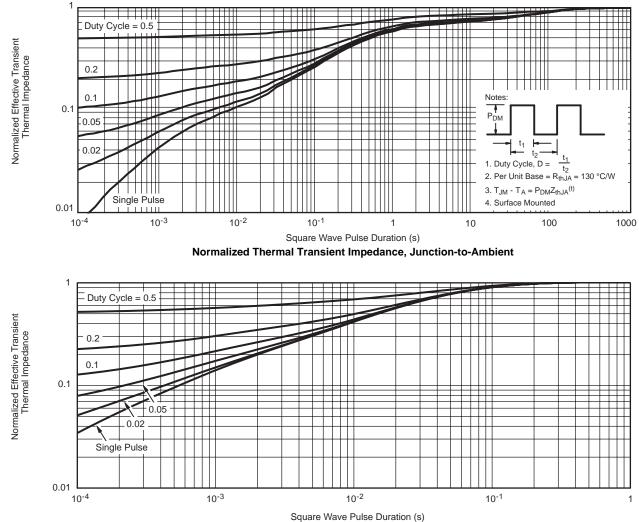






* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

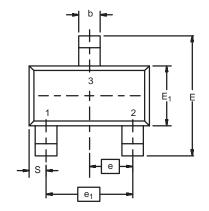




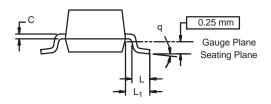
Normalized Thermal Transient Impedance, Junction-to-Foot



SOT-23 (TO-236): 3-LEAD







Dim	MILLIN	METERS	INCHES		
	Min	Max	Min	Max	
Α	0.89	1.12	0.035	0.044	
A ₁	0.01	0.10	0.0004	0.004	
A ₂	0.88	1.02	0.0346	0.040	
b	0.35	0.50	0.014	0.020	
C	0.085	0.18	0.003	0.007	
D	2.80	3.04	0.110	0.120	
E	2.10	2.64	0.083	0.104	
E ₁	1.20	1.40	0.047	0.055	
е	0.95 BSC		0.0374 Ref		
e ₁	1.90 BSC		0.0748 Ref		
L	0.40	0.60	0.016	0.024	
L ₁	0.64 Ref		0.025 Ref		
S	0.50 Ref		0.020 Ref		
q	3°	8°	3°	8°	



RECOMMENDED MINIMUM PADS FOR SOT-23



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



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